

WORLD TRADE ORGANIZATION

RESTRICTED

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**Committee of Participants on the Expansion of Trade
in Information Technology Products**

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PROPOSED ADDITIONS TO PRODUCT COVERAGE

Submission by Australia

The following communication, dated 23 December 1997, has been received from the Permanent Mission of Australia.

Attached please find Australia's proposed product additions for ITA II.

HS Code		Description	Justification
ex	3215.19	Liquid photo-resist for use in the production of printed circuit boards or printed circuit assemblies	
ex	3215.19	Hole plugging and legend inks for use in the production of printed circuit boards or printed circuit assemblies	
ex	3702.95	Dry film photo-resist material for use in the production of printed circuit boards or printed circuit assemblies	
ex	3702.95	Solder mask for use in the production of printer circuit boards or printed circuit assemblies	
ex	3702.95	Conformal coatings for use in the production of printed circuit boards or printed circuit assemblies	
ex	3810.10	Solder paste suspended in a cream flux with additives to promote surface wetting and to control viscosity, drying rate for use in the production of printed circuit boards or printed circuit assemblies	
ex	3810.10	Solder paste flux for use in the production of printed circuit boards or printed circuit assemblies	
ex	3921.90	B-stage B or bonding plies for use in the production of printed circuit boards or printed circuit assemblies	
ex	3921.90	Unreinforced laminates for use in the production of printed circuit boards or printed circuit assemblies	
ex	7016.90	Mass lamination panels for use in the production of printed circuit boards or printed circuit assemblies	
ex	7410.21	Glass reinforced laminates for use in the production of printed circuit boards or printed circuit assemblies	
ex	8419.39 8419.89	Apparatus and equipment for heating by infrared radiation, ultraviolet and thermal energy during printed circuit board or printed wiring board processing	
ex	8420.10 8479.89	Apparatus for application of dry film photo-resist to one or two sides of printed circuit boards or printed wiring boards	
ex	8420.10 8479.89	Apparatus for application, via a roller, liquid photo-sensitive materials to printed circuit boards or printed wiring boards during processing	
ex	8422.20 8424.89	Apparatus for cleaning printed circuit boards or printed wiring boards during the assembly process	
ex	8422.40	Apparatus to enclose or hermetically seal printed circuit board or printed wiring board assemblies	
ex	8424.89	Horizontal wet processing equipment for the application of various chemical or electrochemical solutions during the processing of printed circuit boards or printed wiring boards	

HS Code		Description	Justification
ex	8424.89 8479.89	Apparatus for provision spot application of liquids, solder pastes, adhesives or sealants to selected components	
ex	8424.89 8479.89	Apparatus for application of non-defined coating via flooding during printed circuit boards or printed wiring boards during processing	
ex	8424.89	Vertical wet processing equipment used in the production of printed circuit boards or printed wiring boards	
ex	8428	Automatic material handling machines for the transport, handling and storage of bare or assembled printed circuit board or printed wiring board assemblies	
ex	8443.59	Apparatus for application of defined/non-defined liquids to printed circuit boards or printed wiring boards during processing	
ex	8456.10	Laser hole formation equipment used during printed circuit board or printed wiring board processing	
ex	8456.90	Batch processing equipment used to generate plasma from gases under vacuum during printed circuit board or printed wiring board processing	
ex	8460.39	High-precision apparatus used to re-point carbide drills used in the processing of printed circuit boards or printed wiring boards	
ex	8461.90	Cutting or scoring apparatus used during printed circuit board or printed wiring board processing	
ex	8465.95	Drilling equipment for the processing of printed circuit boards or printed wiring boards	
ex	8465.99	Temperature or pressure-controlled, lamination press used to bond layers into multilayer printed circuit boards or printed wiring boards	
ex	8479.82	Metering or mixing equipment used to extend the life of solutions used during the processing of printed circuit boards or printed wiring boards	
ex	8479.89	Anti-static apparatus used in the removal of dust particles and electrostatic charge during printed circuit board or printed wiring board processing	
ex	8479.89	Registration Equipment to align printed circuit boards during photographic or mechanical processing	
ex	8479.89	Vacuum frames for holding one or more printed circuit boards or printed wiring boards during assembly	
ex	8479.89	Apparatus for placement of components or contact element on semiconductor materials, printed circuit boards or printed wiring boards, ceramic substrates or other substrate materials	

HS Code		Description	Justification
ex	8479.89	Routing equipment used for internal and external profiling during printed circuit board or printed wiring board processing	
ex	8514.30	Apparatus for curing solder or adhesives during printed circuit board or printed wiring board processing	
ex	8515.19	Wet processing apparatus used to clean, strip and plate the edge connectors during printed circuit board or printed wiring board processing	
ex	8515.19	Hot air solder levelling apparatus used to apply molten solder during printed circuit board or printed wiring board processing	
ex	8515.19	Reflow soldering apparatus used during printed circuit board or printed wiring board processing	
ex	8515.19	Apparatus used to bring molten solder into contact with assembled printed circuit boards or printed wiring boards	
ex	8515.19 8479.89	Apparatus for application, coating or laminating of printed circuit boards or printed wiring boards during processing	
ex	9010.50	Exposure equipment used to form an image on a printed circuit board or printed wiring board	
ex	9010.50	Direct image apparatus which forms an image without a mark during printed circuit board or printed wiring board processing	
ex	9010.50 9017.10	Photo plotter for drawing or photo-tool for use in the production of printed circuit boards or printed circuit assemblies	
ex	9022.19	X-ray apparatus for physical inspection of concealed solder joints in printed circuit boards or printed wiring boards	
ex	9030.39	Apparatus for measuring or checking electrical quantities in printed circuit board or printed wiring board assemblies	
ex	9030.39	Electrical bare board test apparatus used to determine continuity or non-continuity of a finished printed circuit board or printed wiring board, known as a Flying Probe	
ex	9030.39	Electrical bare board test apparatus used to determine continuity or non-continuity of a finished printed circuit board or printed wiring board, known as a Fixture	

HS Code		Description	Justification
ex	9031.49	Apparatus for scanning the surface of printed circuit boards or printed wiring boards to compare the image with inputted data	
ex	9031.49	Apparatus for error verification and repair of printed circuit boards or printed wiring boards	

The above goods are used as inputs for, or equipment used to manufacture, printed circuit boards or printed wiring boards and should therefore be included in the ITA.

Australia is prepared to discuss the classification of these goods.

Classification issues

Australia notes that in ITA I, Attachment A, Section 1, a product (Line Telephone Handsets) is classified under ex 8518.30. HS 8518.30 refers to "Headphones, earphones and combined microphone/speaker sets".

Australia contends the product listed in ITA I (Line Telephone Handsets) should not be classified under this HS code, but under HS 8517.

We seek the views of other participants on this matter.
